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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/728,304	12/03/2003	Chien-Te Chen	60417 (71987)	9698
7590 12/01/2004		EXAMINER .		
Mr. Steven M. Jensen			NGUYEN, TUNG X	
Mr. Peter F. Co EDWARDS &	orless ANGELL, LLP		ART UNIT	PAPER NUMBER
101 Federal Street			2829	
Boston, MA	02110		DATE MAILED: 12/01/200-	4

Please find below and/or attached an Office communication concerning this application or proceeding.

	Application No.	Applicant(s)	
	10/728,304	CHEN ET AL.	
Office Action Summary	Examiner	Art Unit	-1/
	Tung X Nguyen	2829	A CO
The MAILING DATE of this communication ap Period for Reply	pears on the cover sheet v	vith the correspondence addr	'ess
A SHORTENED STATUTORY PERIOD FOR REPL THE MAILING DATE OF THIS COMMUNICATION.  - Extensions of time may be available under the provisions of 37 CFR 1.  after SIX (6) MONTHS from the mailing date of this communication.  - If the period for reply specified above is less than thirty (30) days, a rep  - If NO period for reply is specified above, the maximum statutory period  - Failure to reply within the set or extended period for reply will, by statut Any reply received by the Office later than three months after the mailir earned patent term adjustment. See 37 CFR 1.704(b).	136(a). In no event, however, may a ly within the statutory minimum of th will apply and will expire SIX (6) MC e, cause the application to become A	reply be timely filed  irty (30) days will be considered timely.  NTHS from the mailing date of this com  ABANDONED (35 U.S.C. § 133).	munication.
Status			
1)⊠ Responsive to communication(s) filed on <u>03 L</u>	December 2003.		
2a) ☐ This action is FINAL. 2b) ☑ This	s action is non-final.		
3) Since this application is in condition for allowa	ince except for formal ma	tters, prosecution as to the n	nerits is
closed in accordance with the practice under	Ex parte Quayle, 1935 C.	D. 11, 453 O.G. 213.	
Disposition of Claims			
4)⊠ Claim(s) <u>1-17</u> is/are pending in the application	1.		
4a) Of the above claim(s) is/are withdra			
5) Claim(s) is/are allowed.			
6)⊠ Claim(s) 1-17 is/are rejected.			
7) Claim(s) is/are objected to.			
8) Claim(s) are subject to restriction and/o	or election requirement.		
Application Papers			
9)☐ The specification is objected to by the Examin	or	•	
10)⊠ The drawing(s) filed on 03 December 2003 is/		☐ objected to by the Examin	ner
Applicant may not request that any objection to the	· — ·	· ·	101.
Replacement drawing sheet(s) including the correct			? 1 121(d)
11) The oath or declaration is objected to by the E	•		
,	Kammor. Note the attach.		102.
Priority under 35 U.S.C. § 119			
12) Acknowledgment is made of a claim for foreign	n priority under 35 U.S.C.	§ 119(a)-(d) or (f).	
a)⊠ All b) Some * c) None of:			
1. Certified copies of the priority documen			
2. Certified copies of the priority documen			
3. Copies of the certified copies of the price	•	n received in this National S	lage
application from the International Burea		1 1 1	
* See the attached detailed Office action for a lis	t of the certified copies no	ot received.	
,			
Attachment(c)			
Attachment(s)  1) Notice of References Cited (PTO-892)	A) T Intention	Summary (PTO-413)	
2) Notice of Draftsperson's Patent Drawing Review (PTO-948)	Paper No	o(s)/Mail Date	
3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08	,	Informal Patent Application (PTO-1	i <b>5</b> 2)
Paper No(s)/Mail Date  U.S. Patent and Trademark Office	6) <u></u> Other: _	<del></del> ·	
	Action Summary	Part of Paper No./Mai	l Date 1104

Application/Control Number: 10/728,304 Page 2

Art Unit: 2829

## **DETAILED ACTION**

## Claim Rejections - 35 USC § 102

1. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.
- 2. Claims 1-6, and 8, 11-15, 17 are rejected under 35 U.S.C. 102(b) as being anticipated by Admitted Prior Art (heretoafter APA).

As to claims 1, 8, APA discloses a chip carrier for testing electrical performance of a passive component, wherein the chip carrier having at least one passive component mounted on a surface of the chip carrier, the chip carrier comprising: a core layer (figs. 7a-b, between the solder mask layer) having a plurality of conductive traces (82 of figs. 7a-b) formed on at least one surface; the conductive traces (82) comprising:

1. At least one first trace (82a) connected with the passive component (81) and having a first predetermined position (trace 82 of figure 7A is away in two part to be serially connected with a passive component) and two ends (82a, 82b of figure 7a); wherein the two ends are respectively electrically connected to a first bond finger (85) formed on the surface, mounted with the passive component (81); and to a first ball pad (87 of fig. 7a) formed on an opposite surface of the chip carrier (80); wherein the first predetermined position and the first bond finger are located on the same side relative to the passive component (fig. 7b); and

Art Unit: 2829

At least one second trace (82b) free of connection with the passive component (81) and having two ends (82b and 86) and a second predetermined position (part of 82 connected to 86, 87) located on the same surface as the first predetermined position; wherein one of the ends of the second trace is electrically connected to a second ball pad (87 of fig. 7a) located on the same surface as the first ball pad (plurality of 87 of fig. 7a); and

A solder mask layer (outer surface of figure 7b) applied over the conductive traces (82) and formed with a plurality of openings (85, 87 of fig. 7b) for at least exposing the first predetermined position and the second predetermined position.

Two test heads respectively with the first ball pad (87 of figure 8) and second ball pad (85 of figure 8), which are situated on the same surface of the chip carrier, to testing the electrical performance of the passive component (81).

As to claims 2-3, 11-12, the APA discloses the passive component (81) is a resistor or inductor (page 2 in the background).

As to claims 4, 13, the APA discloses (line 16 on page 3 in the background) each of the first predetermined position and the second predetermined position is at least formed with a nickel/gold (Ni/Au) layer.

As to claims 5, 14, the APA discloses the chip carrier (80 figure 7a) is a substrate.

As to claims 6, 15, the APA discloses (page 1 in the background) the chip carrier, wherein the passive component is serially connected to the first trace by means of surface mount technology (SMT).

Application/Control Number: 10/728,304 Page 4

Art Unit: 2829

As to claim 17, the APA discloses the test head is a test probe (61 of figure 8) of a test system.

## Claim Rejections - 35 USC § 103

- 2. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
  - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 3. Claims 7, 16 are rejected under 35 U.S.C. 103(a) as being unpatentable over Admitted Prior Art (heretoafter APA), in view of Hembree et al. (u.s.p 6,078,186)

As to claims 7, 16, the APA discloses all limitation except for the core layer is made of a material selected from the group consisting of FR4 resin, glass resin, BT (bismaleimide triazine) resin, epoxy resin, polyimide resin, and cyanide resin. However, Hembree et al. disclose the core layer is made of FR 4 resin for electrically insulating with the probe to test component on substrate (see brief summary). Therefore, It would have been obvious to a person having ordinary skill in the art at the time the invention was made to modify the system of APA, and provides the FR 4 resin on the surface of core layer, as taught by Hembree et al. for electrically insulating with the probe to test component on subtrate (see brief summary).

4. Claims 9, 10 are rejected under 35 U.S.C. 103(a) as being unpatentable over Admitted Prior Art (heretoafter APA), in view of Pedersen et al. (u.s.p 5,698,895).

Application/Control Number: 10/728,304

Art Unit: 2829

As to claims 9-10, the APA discloses all of the limitations except for the conductive

Page 5

jig made by conductive rubber or metal. However, Pedersen et al. disclose the

conductive jig consider to be conductive fuse (50a of figure 2) for enabling the passive

component tested on the same time (col. 10, lines 1-10). Therefore, It would have been

obvious to a person having ordinary skill in the art at the time the invention was made to

modify the system of APA, and provides the conductive jig, as taught by Pedersen et al.

for enabling the passive component tested on the same time (col. 10, lines 1-10).

5. Any inquiry concerning this communication or earlier communications from the

examiner should be directed to Tung X Nguyen whose telephone number is (571) 272-

1967. The examiner can normally be reached on 8:30am-5:00pm M-F.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's

supervisor, Michael Tokar can be reached on (571) 272-1812. The fax phone number

for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the

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TN

11/22/04

winhard J. Tokan Michael Tokar

Supervisory Patent Examiner Technology Center 2800